PAGE2 Power Tree PAGE3 Block Diagram PAGE4 Power on board PAGE5 Power Ctrl PAGE6 Unit 1 of Hi3798M(NAND/USB3.0/IR/SDIO/XTAL/FE) PAGE7 Unit 2 of Hi3798M(JTAG/USB2.0/HDMI TX/DAC/I2S/SPI/UART) PAGE8 Unit 3 of Hi3798M(DDR3) PAGE9 Unit 4 of Hi3798M(POWER) PAGE10 Unit 5 of Hi3798M(VSS) PAGE11 **DDRA** Hi3798MDMO1A PAGE12 **DDRB** PAGE13 NAND FLASH/EMMC PAGE14 USB2.0/USB3.0/WIFI PAGE15 SD CARD/IR VER E V1.0.0.0 PAGE16 Audio Output PAGE17 FE PHY/UART PAGE18 VDAC OUTPUT PAGE19 HDMI TX Hi3798MV100 DEMO Board 4 layers PCB with 2 DDR3 16bit Board Size:86mm x 88mm x 1.6mm

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Title Page

The type and specification of the components refer to the BOM

					NA	20	2013-07-04 DATE		
					ECA NO				
DESIGNED	TIANSHOU 0017	1014	HI3798MDMO1A_VERE						
		HI37				00001234			
REVIEWED	CHENYUZHU 001	49603							
		VER	PA	RT_NUMBER	SHEET	1	OF	19	
		A	03	030001	HUAW	ΈI	TECH	I CO.,	LTD
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